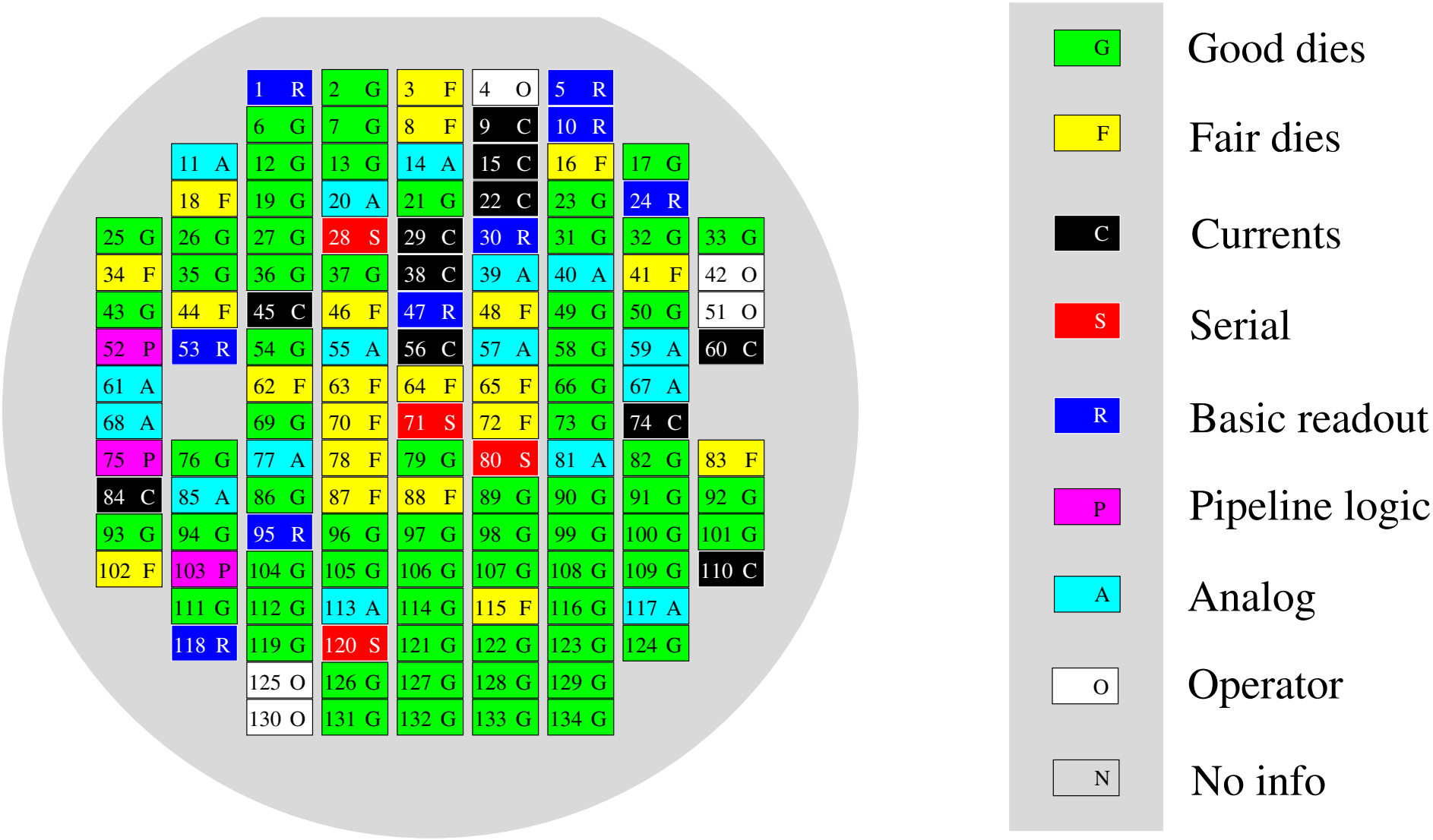
Types of die failures for wafer 168 s/n: Y21316-12-06

Date: 07/06/99